



WW25M_J

±5%, ±1%

Metal low ohm current sensing chip resistors Size 2512 (6432) 1W

Automotive AEC Q200 Compliant

Anti-Sulfuration ASTM B-809 105'C 1000hrs

nology

RoHS Exemption free and Lead free products

Halogen free

*Contents in this sheet are subject to change without prior notice.

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FEATURE

- 1. Metal low ohm and stable TCR performance
- 2. Automotive grade AEC Q-200 compliant
- 3. 100% CCD inspection
- 4. RoHS Exemption free and Lead free products
- 5. ASTM B-809 105'C 1000hrs compliant

APPLICATION

- Power supply
- PDA
- Digital meter
- Computer
- Automotives
- Battery charger
- DC-DC power converter

DESCRIPTION

The resistors are constructed in a high grade low resistive metal body. The resistive layer is covered with a protective coat and printed a resistance marking code over it. Finally, the two external end terminations are added. For ease of soldering the outer layer of these end terminations is Tin (lead-free) soder alloy.

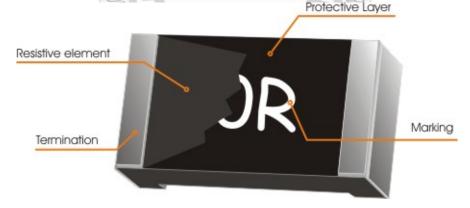


Fig 1. Construction of Chip-R

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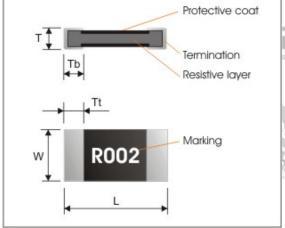




QUICK REFERENCE DATA

Item	General Sp	pecification		
Series No.	ww	25M		
Size code	2512 (6432)		
Resistance Tolerance	±5%,	±1%		
Resistance Value	0.001Ω, 0.002Ω	$\begin{array}{c} 0.003\Omega, \ 0.004\Omega, \ 0.005\Omega, \\ 0.006\Omega, \ 0.007\Omega, \ 0.008\Omega, \\ 0.009\Omega, \ 0.010\Omega, \ 0.012\Omega, \\ 0.015\Omega, \ 0.020\Omega, \ 0.022\Omega, \\ 0.025\Omega, \ 0.030\Omega, \ 0.033\Omega, \\ 0.035\Omega, \ 0.040\Omega, \ 0.050\Omega, \\ 0.060\Omega, \ 0.070\Omega, \ 0.075\Omega, \\ 0.080\Omega, \ 0.100\Omega, \end{array}$		
TCR (ppm/°C)	≤±70 ppm/°C	≤±50 ppm/°C		
Max. dissipation at T _{amb} =70°C	1\	1W		
Max. Operation current (DC or RMS)	SQRT (Power	SQRT (Power / Resistance)		
Operation temperature	-55 ~ +170°C			

MECHANICAL DATA



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SIVE	Symbol	R001, R002	R003 – R100
	L	6.40±0.25	6.20±0.25
	W	3.25±0.20	3.25±0.20
	Т	0.75±0.20	0.60±0.20
INUL	Tt	2.00±0.20	0.80±0.20
	Tb	2.00±0.20	0.80±0.20



MARKING

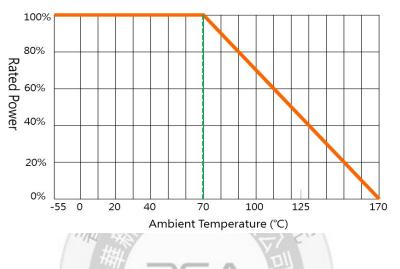
Each resistor is marked with a four-digit code on the protection coat to define resistance value. Example:

 $R025 = 0.025\Omega$, $R050 = 0.05\Omega$

FUNCTIONAL DESCRIPTION

Derating curve

The power that the resistor can dissipate depends on the operating temperature.



MOUNTING

Due to their rectangular shapes and small tolerances, Surface Mountable Resistors are suitable for handling by automatic placement systems.

Chip placement can be on ceramic substrates and printed-circuit boards (PCBs).

Electrical connection to the circuit is by individual soldering condition.

The end terminations guarantee a reliable contact.



SOLDERING CONDITION

The robust construction of chip resistors allows them to be completely immersed in a solder bath of 260°C for 10 seconds. Therefore, it is possible to mount Surface Mount Resistors on one side of a PCB and other discrete components on the reverse (mixed PCBs).

Surface Mount Resistors are tested for solderability at 235°C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds. Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 3.

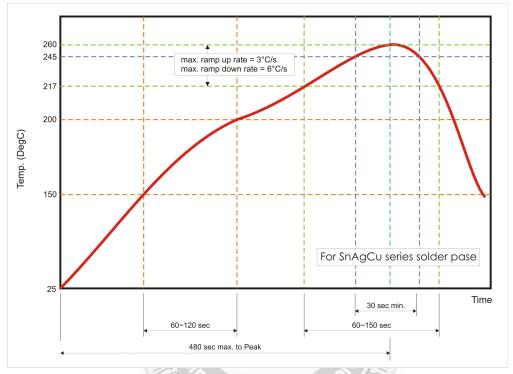


Fig 3. Infrared soldering profile for Chip Resistors WW25M

CATALOGUE NUMBERS

The resistors have a catalogue number starting with

WW25	М	R025	J	Т	L	J
Size code WW25 : 2512	Type code M : 1W Sensing type	Resistance code $0.025\Omega = R025$	Tolerance J : ±5% F : ±1%	Packaging code T : 7" reeled in tape	Termination code L = Sn base (lead free)	Special code J = Automotive grade AEC Q-200 compliant ASTM B-809 compliant

Reeled tape packaging : 12mm width plastic emboss taping 4,000pcs per reel.

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TEST AND REQUIREMENTS (AEC Q-200)

TEST		REQUIREMENT		
IESI	PROCEDURE / TEST METHOD	Resistor		
Electrical Characteristics JISC5201-1: 1998	 DC resistance values measurement Temperature Coefficient of Resistance (T.C.R) Natural resistance change per change in degree centigrade. 	Within the specified tolerance Refer to "QUICK REFERENCE DATA"		
Clause 4.8	$\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)} t_1 : 20^\circ\text{C+5°C-1°C}$			
	R ₁ : Resistance at reference temperature R ₂ : Resistance at test temperature			
Resistance to soldering heat (R.S.H) MIL-STD-202 method 210	Un-mounted chips completely immersed for 10 ± 1 second in a SAC solder bath at $270^{\circ}C\pm5^{\circ}C$	Δ R/R max. ±(0.5%+0.5m Ω) no visible damage		
Solderability J-STD-002	 a) Bake the sample for 155°C dwell time 4hrs/ solder dipping 235°C/ 5sec. b) Steam the sample dwell time 8 hour/ solder dipping 215°C/ 5sec. c) Steam the sample dwell time 8 hour/ solder dipping 260°C/ 7sec. 	95% coverage min., good tinning and no visible damage		
Temperature cycling JESD22 Method JA-104	1000 cycles, -55°C ~ +125°C , dwell time 30min maximum.	ΔR/R max. ±(0.5%+1mΩ) No visible damage		
Moisture Resistance MIL-STD-202 method 106	65±2°C, 80~100% RH, 10 cycles, 24 hours/ cycle	ΔR/R max. ±(0.5%+0.5mΩ) No visible damage		
Bias Humidity MIL-STD-202 method 103	1000+48/-0 hours; 85°C, 85% RH, 10% of operation power	∆R/R max. ±(1%+0.5mΩ) No visible damage		
Operational Life MIL-STD-202 method 108	1000+48/-0 hours; 35% of operation power, 125±2°C	∆R/R max. ±(1%+0.5mΩ) No visible damage		
High Temperature Exposure MIL-STD-202 Method 108	Test 1000 hrs./ @T=170℃/ Un-powered. Measurement at 24±2 hours after test conclusion.	ΔR/R max. ±(1%+0.5mΩ) No visible damage		
Board Flex AEC-Q200-005	Resistors mounted on a 90mm glass epoxy resin PCB(FR4),bending once 2mm for 60sec.	Δ R/R max. ±(0.5%+0.5m Ω) No visible damage		
Terminal strength AEC-Q200-006	Pressurizing force: 1.8Kg, Test time: 60±1sec.	No remarkable damage or removal of the terminations		
Thermal shock MIL-STD-202 method 107	Test –55 to 155° C / dwell time 15min/ Max transfer time 20sec 300cycles	Δ R/R max. ±(0.5%+0.5m Ω) No visible damage		
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ESD AEC-Q200-002	Test contact 1KV (Min)	∆R/R max. ±(1%+0.5mΩ) No visible damage	
Mechanical Shock MIL-STD-202 method 213	Test ½ Sine Pulse, Peak value: 100g, normal duration: 6ms, Velocity change:12.3ft/sec. Three shocks in each direction, total 18 shocks.	Within product specification tolerance and no visible damage.	
Vibration MIL-STD-202 method 204	Test 5g's for 20 min., 12 cycles each of 3 orientations.	\triangle R/R max. ±(0.5%+0.5m Ω) no visible damage.	
Resistance to Solvents : MIL-STD-202 Method 215	Solvent is Isopropyl alcohol, immersion 3mins at 25° C and brush 10 strokes with a toothbrush with a handle made of a non-reactive material (wet bristle), immersion and brush 3 times and then air blow dry.	No superficial defect on marking, encapsulation, coating, appearance. Electrical characteristics within products specification and tolerance. Inspect at 3X max. for marking, inspect at 10X for part damage.	
External Visual MIL-STD-883 method 2009	Electrical test not required. Inspect device construction, marking and workmanship	No visual damage and refer WTC marking code.	
Physical Dimension JESD22 method JB-100	Verify physical dimensions(L, W, T, Tb, Tt)	Within the specified tolerance for WTC.	
Sulfuration test ASTM B-809-95	ASTM B-809-95 105'C 1000hrs	\triangle R/R max. ±(2%+0.5m Ω) no visible damage.	
Short time overload (S.T.O.L) Clause 4.13	5×Rated power for 5 seconds.	no visible damage ∆R/R max.±1%	

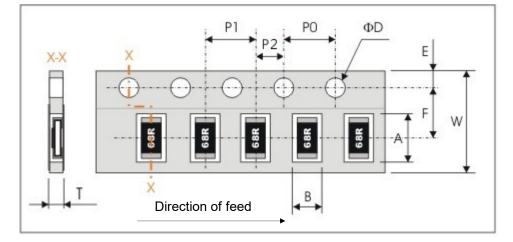
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PACKAGING

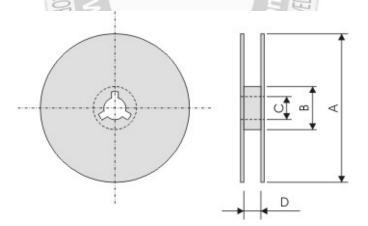
Plastic Tape specifications (unit :mm)



Symbol	A	В	W	F	E
Dimensions	6.75±0.20	3.50±0.20	12.00±0.30	5.50±0.1	1.75±0.10
	1.	日本 日本	ASTRON		

Symbol	P1	PO PO	P2 0	ΦD	Т
Dimensions	4.00±0.10	4.00±0.10	2.00±0.10	$\Phi 1.50^{+0.1}_{-0.0}$	1.0±0.2

Reel dimensions



Symbol	А	В	С	D
(unit : mm)	Φ178.0±2.0	Φ60.0±1.0	13.0±0.2	14.0±0.2

Taping quantity

- Chip resistors 4,000 pcs per reel.

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